

DATA IMAGE CORPORATION

LCD Module Specification

ITEM NO.: GM126401SFAYA-R1

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Version:	Issued Date:	Sheet Code:	Total Pages:
B	2003/4/1		21

2. RECORD OF REVISION

Rev	Date	Item	Page	Comment
B	AUG/02/02	11.2.3, 11.3	16-17	1.Change: 11.2.3 Inspection Parameters. 2. Add on11.3 Sampling increase Condition.
	AUG/02/02	13	18	New model numbering system is updated from old P/N# GM12641DS1L1Y-02
B	APR/01/03	15	20	Modify: OUTLINE DRAWING.

3. GENERAL SPECIFICATION

Display Format : 128 (W) × 64 (H) dots
Dot Size : 0.48 (W) × 0.48 (H) mm
View Area : 72.5 (W) × 39.5 (H) mm
General Dimensions : 93 (W) × 70 (H) × 12.5 (T) mm Max.

Weight : 83 g max.

LCD Type : ☐ STN Gray ☒ STN Yellow ☐ FSTN

Polarizer mode : ☐ Reflective ☒ Transflective

☐ Transmissive ☐ Negative

View Angle : ☒ 6 O'clock ☐ 12 O'clock ☐ Others _____

Backlight : ☒ LED ☐ EL ☐ CCFL

Backlight Color : ☒ Yellow green ☐ Amber ☐ Blue Green

☐ White ☐ Others

Controller / Driver : KS0107/KS0108

Temperature Range : ☒ Normal ☐ Wide Temperature
Operating 0 to 50°C Operating -20 to 70°C
Storage -20 to 70°C Storage -30 to 80°C

4. ABSOLUTE MAXIMUM RATINGS

4.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS

$V_{SS}=0V$, $T_a = 25^{\circ}C$

Item	Symbol	Min.	Max.	Unit
Supply Voltage (Logic)	$V_{DD}-V_{SS}$	0	8	V
Supply Voltage (LCD Driver)	$V_{DD}-V_O$	0	16.5	V
Input Voltage	V_I	$V_{SS}-0.3$	$V_{DD}+0.3$	V
Operating Temperature	T_{OP}	0	50	$^{\circ}C$
Storage Temperature	T_{STG}	-20	70	$^{\circ}C$

4.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

Item	Operating		Storage		Comment
	(Min.)	Max.)	(Min.)	(Max.)	
Ambient Temp	0	50	-20	70	Note (1)
Humidity	Note (2)		Note(2)		Without Condensation
Vibration	--	$4.9M/S^2$	--	$19.6M/S^2$	XYZ Direction
Shock	--	$29.4M/S^2$	--	$490M/S^2$	XYZ Direction

Note(1) $T_a = 0^{\circ}C$: 50Hr Max.

Note(2) $T_a \leq 40^{\circ}C$: 90% RH Max.

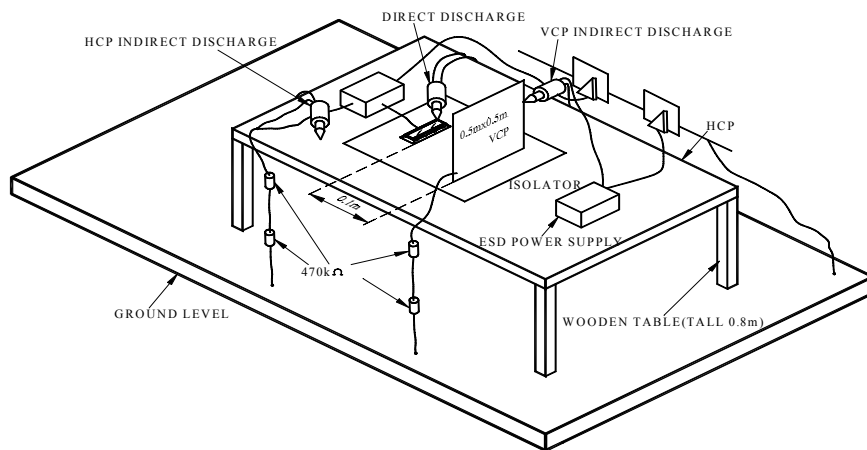
$T_a \geq 40^{\circ}C$: Absolute humidity must be lower than the humidity of 90% RH at $40^{\circ}C$.

4.3 Electronic Static Discharge maximum rating

ESD test method : IEC1000-4-2

Item	Description
Testing environment	Ambient temperature : 15°C to 35 °C Humidity: 30% to 60 % LCM (E.U.T) : Power up
Testing equipment	Manufacture: Noise Ken, Model No. ESD-100L
Testing condition	See drawing 1
Direct discharge	0 to ± 6 KV Discharge point, see drawing 2
Indirect discharge	0 to ± 12 KV Discharge point, see drawing 1
Pass condition	No malfunction of unit. Temporary malfunction of unit which can be recovered by system reset
Fail condition	Non. Recoverable malfunction of LCM or system

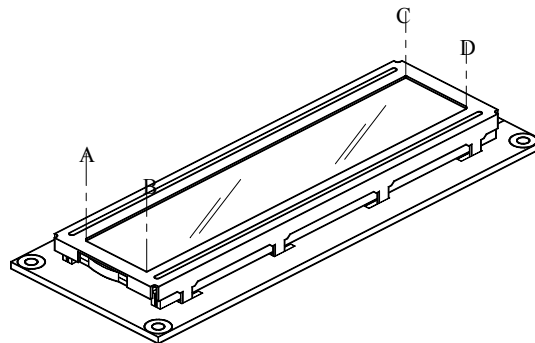
FIG 1 ESD TESTING EQUIPMENT



(1)

DIRECT CONTACT DISCHARGE

CONTACT POINT : A.B.C.D



(2)

5. ELECTRICAL CHARACTERISTICS

Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Supply Voltage (Logic)	V _{DD} -V _{SS}		4.5	5.0	5.5	V
Supply Voltage (LCD)	V _{DD} -V _O	0°C	9.0	9.5	10.0	V
		25°C	8.6	9.3	9.7	
		50°C	8.2	8.8	9.2	
Input Voltage	V _{IH}	--	0.7V _{SS}	--	V _{DD}	V
	V _{IL}		V _{SS}	--	0.3V _{DD}	
Logic Supply Current	I _{DD}	V _{DD} -V _{SS} =5V	--	3.8	6	mA

6. ELECTRO-OPTICAL CHARACTERISTICS

ITEM	Symbol	Condition	Min.	Typ.	Max.	Unit	Ref.
Rise Time	Tr	0°C	--	400	600	Ms	Note (1)
		25°C	--	110	170		
Fall Time	Tf	0°C	--	500	800	Ms	
		25°C	--	110	170		
Contrast	CR	25°C	--	3	--		Note (3)
View Angle	θ1~θ2 Ø1, Ø2	25°C & CR≥1.5	60	--	--		Note (2)
			-30	--	30		
Frame Frequency	Ff	25°C	--	64	--	Hz	

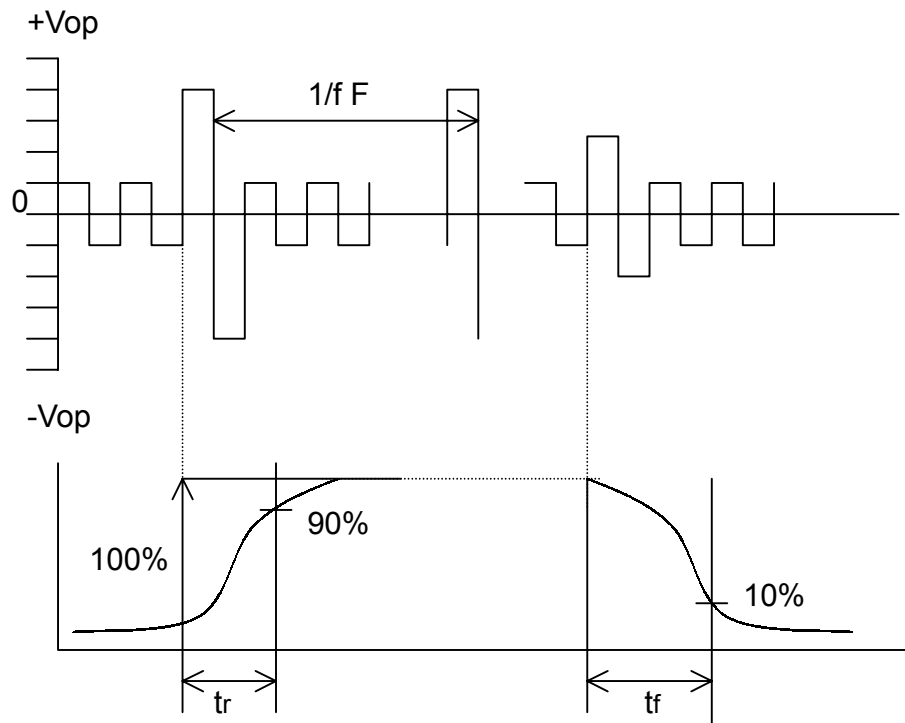
Note (1) & (2) : See next page

Note (3) : Contrast ratio is defined under the following condition:

$$CR = \frac{\text{Brightness of non-selected condition}}{\text{Brightness of selected condition}}$$

- (a). Temperature ----- 25°C
- (b). Frame frequency ---- 64Hz
- (c). Viewing angle ----- θ= 0°, Ø = 0°
- (d). Operating voltage --- 9.3V

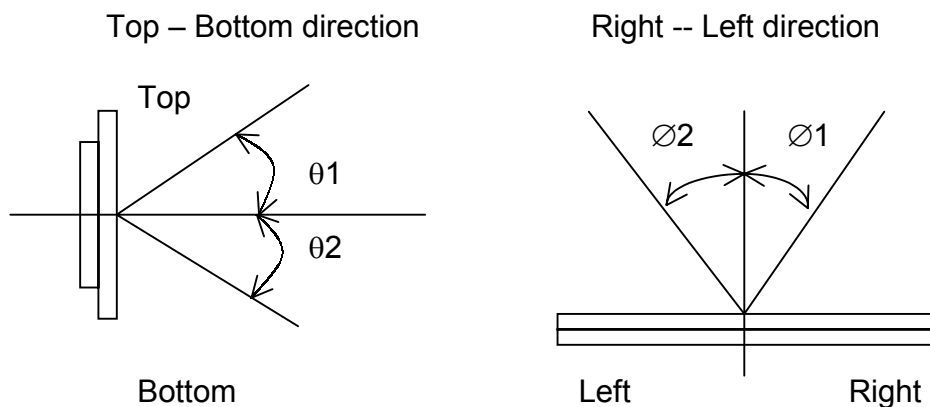
Note (1) Response time is measured as the shortest period of time possible between the change in state of an LCD segment as demonstrated below:



Condition:

- (a) . Temperature ----- 25°C
- (b) . Frame frequency ----- 64Hz
- (c) . View Angle ----- $\theta = 0^{\circ}, \phi = 0^{\circ}$
- (d) . Operating voltage ----- 9.3V

Note (2) Definition of View Angle



6.1 LED ELECTRO-OPTICAL CHARACTERISTIC

$T_a = 25^{\circ}\text{C}$

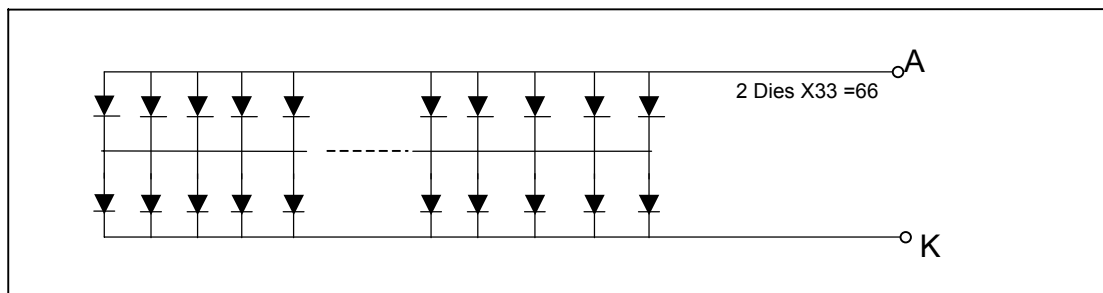
Item	Symbol	Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V_F	$I_F = 330\text{mA}$ Yellow Green	--	4.2	4.6	V
Luminous Intensity	I_V	$I_F = 330\text{mA}$ Yellow Green	120	180	--	cd/m^2
Peak Emission	λ_P	$I_F = 330\text{mA}$ Yellow Green	--	570	--	nm
Spectrum Radiation	$\Delta\lambda$	$I_F = 330\text{mA}$ Yellow Green	--	30	--	nm
Reverse Current	I_R	$V_R = 8\text{V}$ Yellow Green	--	--	0.2	mA

Note : Measured at the LED backlight unit.

6.2 LED MAXIMUM OPERATING RANGE

Item	Symbol	Yellow Green	Unit
Power Dissipation	PAD	2.3	W
Forward Current	I_{AF}	495	mA
Reverse Voltage	V_R	8	V

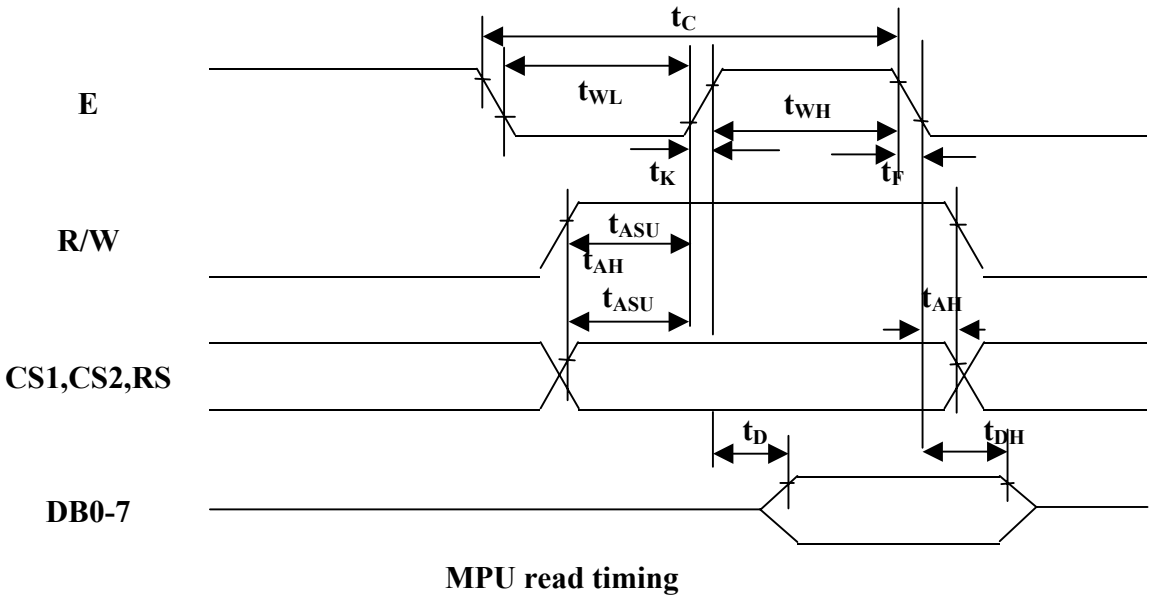
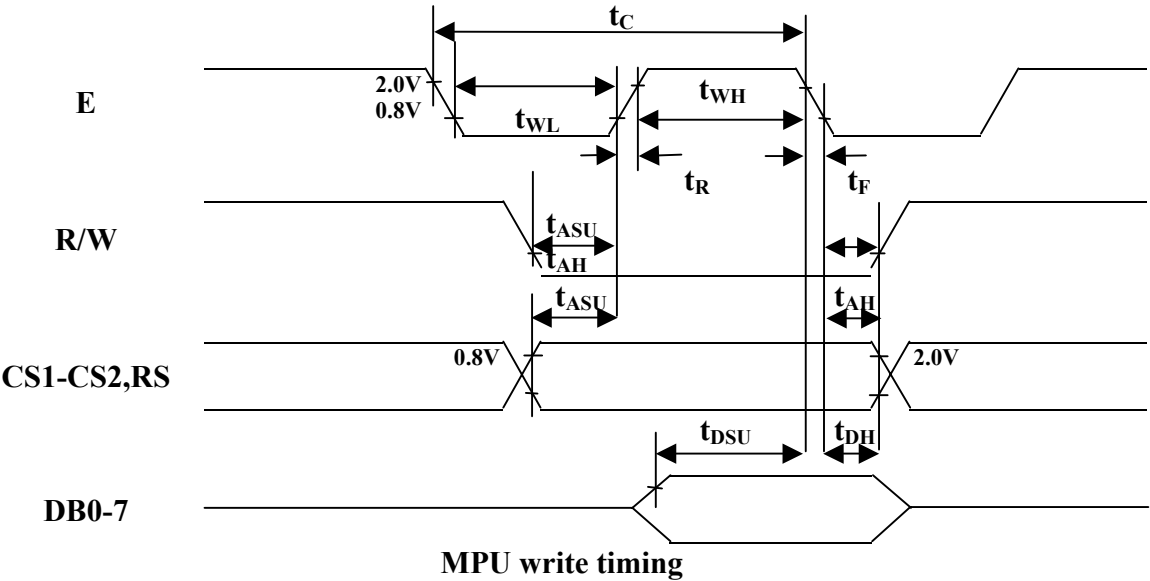
6.2.1 LED ARRAY BLOCK DIAGRAM



7. TIMING CHARACTERISTICS

MPU Interface

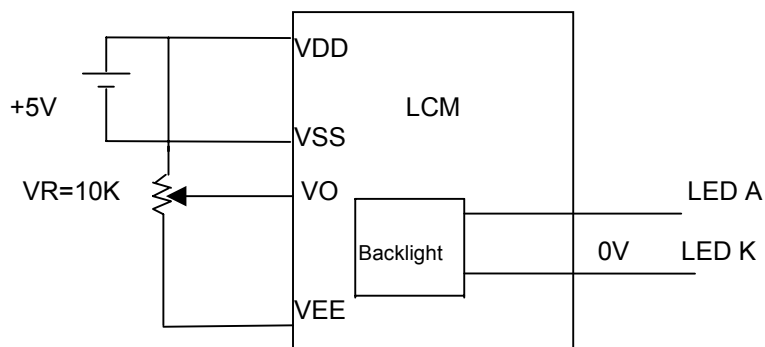
Characteristic	Symbol	Min	Typ	Max	Unit
E Cycle	t_C	1000	--	--	ns
E High Level Width	t_{WH}	450	--	--	ns
E Low Level Width	t_{WL}	450	--	--	ns
E Rise Time	t_R	--	--	25	ns
E Fall Time	t_F	--	--	25	ns
Address Set-Up Time	t_{ASU}	140	--	--	ns
Address Hold Time	t_{AH}	10	--	--	ns
Data Set-Up Time	t_{SU}	200	--	--	ns
Data Delay Time	t_D	--	--	320	ns
Data Hold Time (Write)	t_{DHW}	10	--	--	ns
Data Hold Time (Read)	t_{DHR}	20	--	--	ns



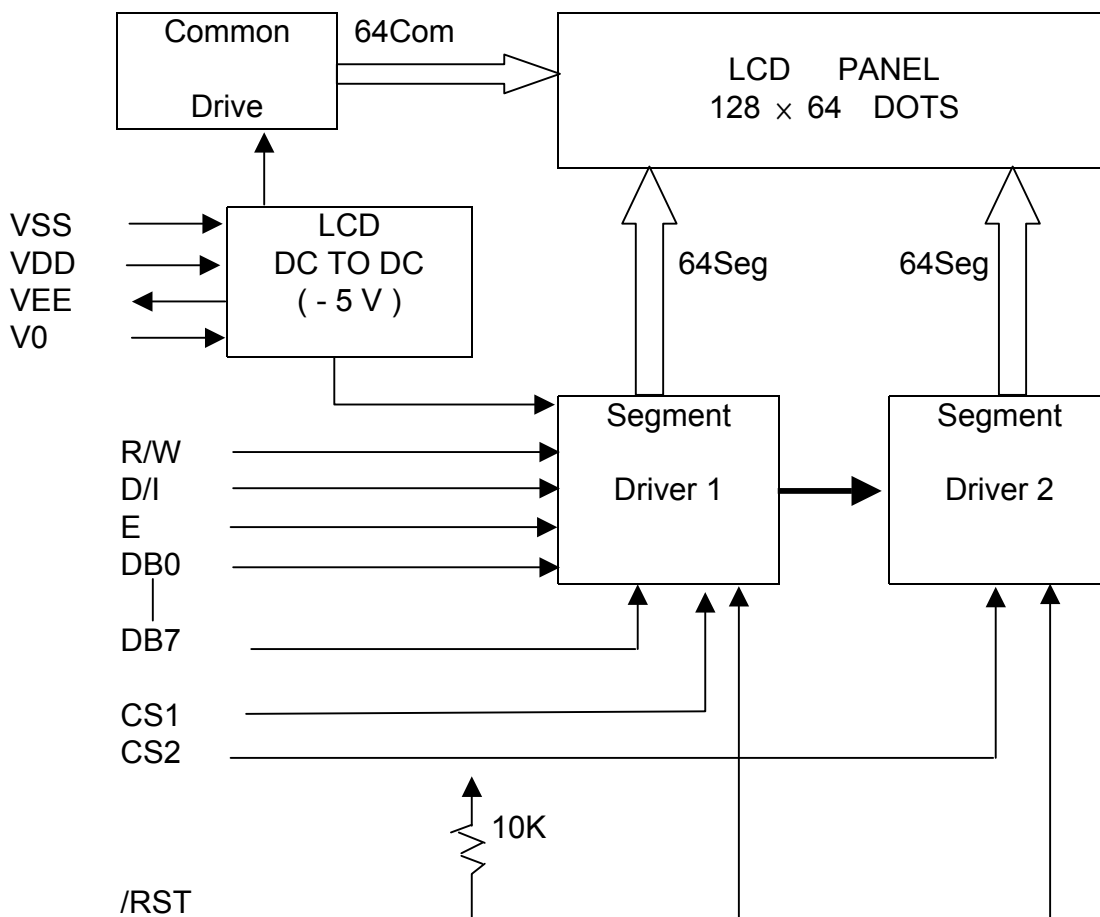
8. PIN CONNECTIONS

No.	Symbol	Function
1	V _{SS}	Ground (0V)
2	V _{DD}	+5V
3	V ₀	Power Supply For LCD Drive
4	D/I	L→ Instructions H→ Data
5	R/W	H→ Data Read (LCD → MPU) L→ Data Write (LCD ← MPU)
6	E	Enable Signal
7	DB0	Data Bus Line
8	DB1	
9	DB2	
10	DB3	
11	DB4	
12	DB5	
13	DB6	
14	DB7	
15	CS1	Chip select for IC1, Active high
16	CS2	Chip select for IC2, Active high
17	/RST	Reset, Active LOW
18	V _{EE}	Negative Voltage Output
19	LEDK	LED Cathode. Power Supply -
20	LEDA	LED Anode. Power Supply +

9. POWER SUPPLY



10. BLOCK DIAGRAM



DISPLAY CONTROL INSTRUCTION

The display control instructions control the internal state of the KS0108B . Instruction is received from MPU to KS0108B for the display control. The following table shows various instructions.

Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Function
Display ON/OFF	L	L	L	L	H	H	H	H	H	L/H	Controls the display on or off. Internal status and display RAM data is not affected. L : OFF, H : ON
Set Address	L	L	L	H	Y address (0-63)						Sets the Y address in the Y address counter.
Set Page (X address)	L	L	H	L	H	H	H	Page (0-7)			Sets the X address at the X address counter.
Display Start Line	L	L	H	H	Display start line (0-63)						Indicates the display data RAM displayed at the top of the screen
Status Read	L	H	B U S Y	L	O N / O F F	R E S E T	L	L	L	L	Read status. BUSY L: Ready H: In operation ON/OFF L: Display ON H: Display OFF RESET L: Normal H: Reset
Write Display Data	H	L	Write Data								Writes data (DB0:7) into display data RAM. After writing instruction, Y address is increased by 1 automatically.
Read Display Data	H	H	Read Data								Read data (DB0:7) from display data RAM to the data bus.

11. QUALITY ASSURANCE

11.1 Test Condition

11.1.1 Temperature and Humidity(Ambient Temperature)

Temperature : $20 \pm 5^{\circ}\text{C}$

Humidity : $65 \pm 5\%$

11.1.2 Operation

Unless specified otherwise, test will be conducted with LCM in operation.

11.1.3 Container

Unless specified otherwise, vibration test will be conducted on module only.

11.1.4 Test Frequency

Single cycle.

11.1.5 Test Method

No.	Parameter	Conditions	Regulations
1	High Temperature Operating	$50 \pm 2^{\circ}\text{C}$	Note 3
2	Low Temperature Operating	$0 \pm 2^{\circ}\text{C}$	Note 3
3	High Temperature Storage	$70 \pm 2^{\circ}\text{C}$	Note 3
4	Low Temperature Storage	$-20 \pm 2^{\circ}\text{C}$	Note 3
5	Vibration Test (Non-operation state)	Total fixed amplitude : 1.5mm Vibration Frequency : 10 ~ 55Hz One cycle 60 seconds to 3 directions of X.Y.Z. for each 15 minutes	Note 3
6	Damp Proof Test (Non-operation state)	$40^{\circ}\text{C} \pm 2^{\circ}\text{C}$, 90~95%RH, 96h	Note 1,2
7	Shock Test (Non-operation state)	To be measured after dropping from 60cm high once concrete surface in packing state	Note 3

Note 1: Returned under normal temperature and humidity for 4 hrs.

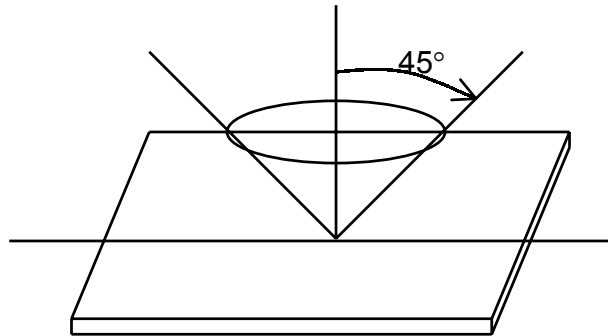
Note 2: No dew condensation to be observed.

Note 3: No change on display and in operation under the test condition

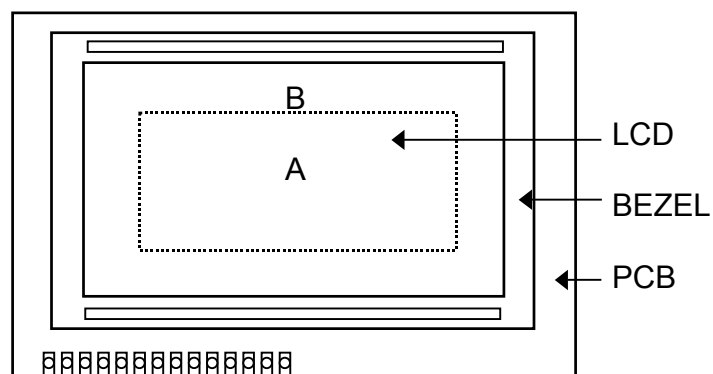
11.2 Inspection condition

11.2.1 Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.

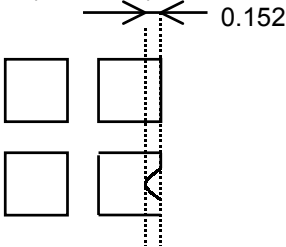


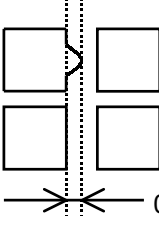
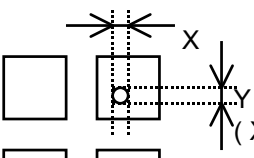
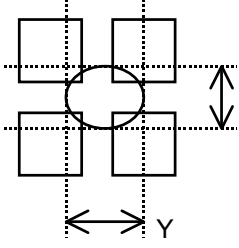
11.2.2 Definition of applicable Zones



A : Display Area
B : Non-Display Area

11.2.3 Inspection Parameters

No.	Parameter	Criteria																												
1	Black or White spots	<table><tr><th rowspan="2">Zone Dimension</th><th colspan="2">Acceptable number</th><th rowspan="2">Class Of Defects</th><th rowspan="2">AQL Level</th></tr><tr><th>A</th><th>B</th></tr><tr><td>D < 0.15</td><td>*</td><td>*</td><td rowspan="4">Minor</td><td rowspan="4">2.5</td></tr><tr><td>0.15 ≤ D < 0.2</td><td>4</td><td>4</td></tr><tr><td>0.2 ≤ D ≤ 0.25</td><td>2</td><td>2</td></tr><tr><td>D ≤ 0.3</td><td>0</td><td>1</td></tr></table> <p>D = (Long + Short) / 2 * : Disregard</p>	Zone Dimension	Acceptable number		Class Of Defects	AQL Level	A	B	D < 0.15	*	*	Minor	2.5	0.15 ≤ D < 0.2	4	4	0.2 ≤ D ≤ 0.25	2	2	D ≤ 0.3	0	1							
Zone Dimension	Acceptable number			Class Of Defects	AQL Level																									
	A	B																												
D < 0.15	*	*	Minor	2.5																										
0.15 ≤ D < 0.2	4	4																												
0.2 ≤ D ≤ 0.25	2	2																												
D ≤ 0.3	0	1																												
2	Scratch, Substances	<table><tr><th colspan="2">Zone</th><th colspan="2">Acceptable number</th><th rowspan="2">Class Of Defects</th><th rowspan="2">AQL Level</th></tr><tr><th>X (mm)</th><th>Y(mm)</th><th>A</th><th>B</th></tr><tr><td>*</td><td>0.04 ≥ W</td><td>*</td><td>*</td><td rowspan="4">Minor</td><td rowspan="4">2.5</td></tr><tr><td>3.0 ≥ L</td><td>0.06 ≥ W</td><td>4</td><td>4</td></tr><tr><td>2.0 ≥ L</td><td>0.08 ≥ W</td><td>2</td><td>3</td></tr><tr><td>—</td><td>0.1 < W</td><td>0</td><td>1</td></tr></table> <p>X : Length Y : Width * : Disregard Total defects should not exceed 4/module</p>	Zone		Acceptable number		Class Of Defects	AQL Level	X (mm)	Y(mm)	A	B	*	0.04 ≥ W	*	*	Minor	2.5	3.0 ≥ L	0.06 ≥ W	4	4	2.0 ≥ L	0.08 ≥ W	2	3	—	0.1 < W	0	1
Zone		Acceptable number		Class Of Defects	AQL Level																									
X (mm)	Y(mm)	A	B																											
*	0.04 ≥ W	*	*	Minor	2.5																									
3.0 ≥ L	0.06 ≥ W	4	4																											
2.0 ≥ L	0.08 ≥ W	2	3																											
—	0.1 < W	0	1																											
3	Air Bubbles (between glass & polarizer)	<table><tr><th rowspan="2">Zone Dimension</th><th colspan="2">Acceptable number</th><th rowspan="2">Class of Defects</th><th rowspan="2">AQL Level</th></tr><tr><th>A</th><th>B</th></tr><tr><td>D ≤ 0.15</td><td>*</td><td>*</td><td rowspan="3">Minor</td><td rowspan="3">2.5</td></tr><tr><td>0.15 < D ≤ 0.25</td><td>2</td><td>*</td></tr><tr><td>0.25 < D</td><td>0</td><td>1</td></tr></table> <p>* : Disregard Total defects shall not excess 3/module.</p>	Zone Dimension	Acceptable number		Class of Defects	AQL Level	A	B	D ≤ 0.15	*	*	Minor	2.5	0.15 < D ≤ 0.25	2	*	0.25 < D	0	1										
Zone Dimension	Acceptable number			Class of Defects	AQL Level																									
	A	B																												
D ≤ 0.15	*	*	Minor	2.5																										
0.15 < D ≤ 0.25	2	*																												
0.25 < D	0	1																												
4	Uniformity of Pixel	<p>(1) Pixel shape (with Dent)</p> 																												

4	Uniformity of Pixel		<p>(2) Pixel shape (with Projection)</p>  <p>Should not be connected to next pixel</p> <p>0.152</p> <p>(3) Pin hole</p>  <p>$(X + Y) / 2 \leq 0.02\text{mm}$</p> <p>(Less than 0.1 mm is no counted)</p> <p>(4) Deformation</p>  <p>$(X + Y) / 2 \leq 0.3\text{mm}$</p> <p>Total acceptable number : 1/pixel, 5/cell</p>
Class of defects	Major	AQL 0.65%	Definition
		AQL 1.00%	It is a defect that is likely to result in failure or to reduce materially the usability of the product for the intended function.
	Minor	AQL 2.5%	It is a defect that is likely to assembly size and not result in functioning problem.
			It is a defect that will not result in functioning problem with deviation classified.

11.3 Sampling Condition

Unless otherwise agree in written, the sampling inspection shall be applied to the incoming inspection of customer.

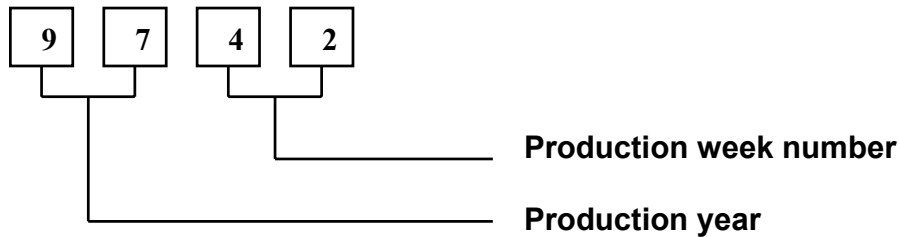
Lot size: Quantity of shipment lot per model.

Sampling type: normal inspection, single sampling

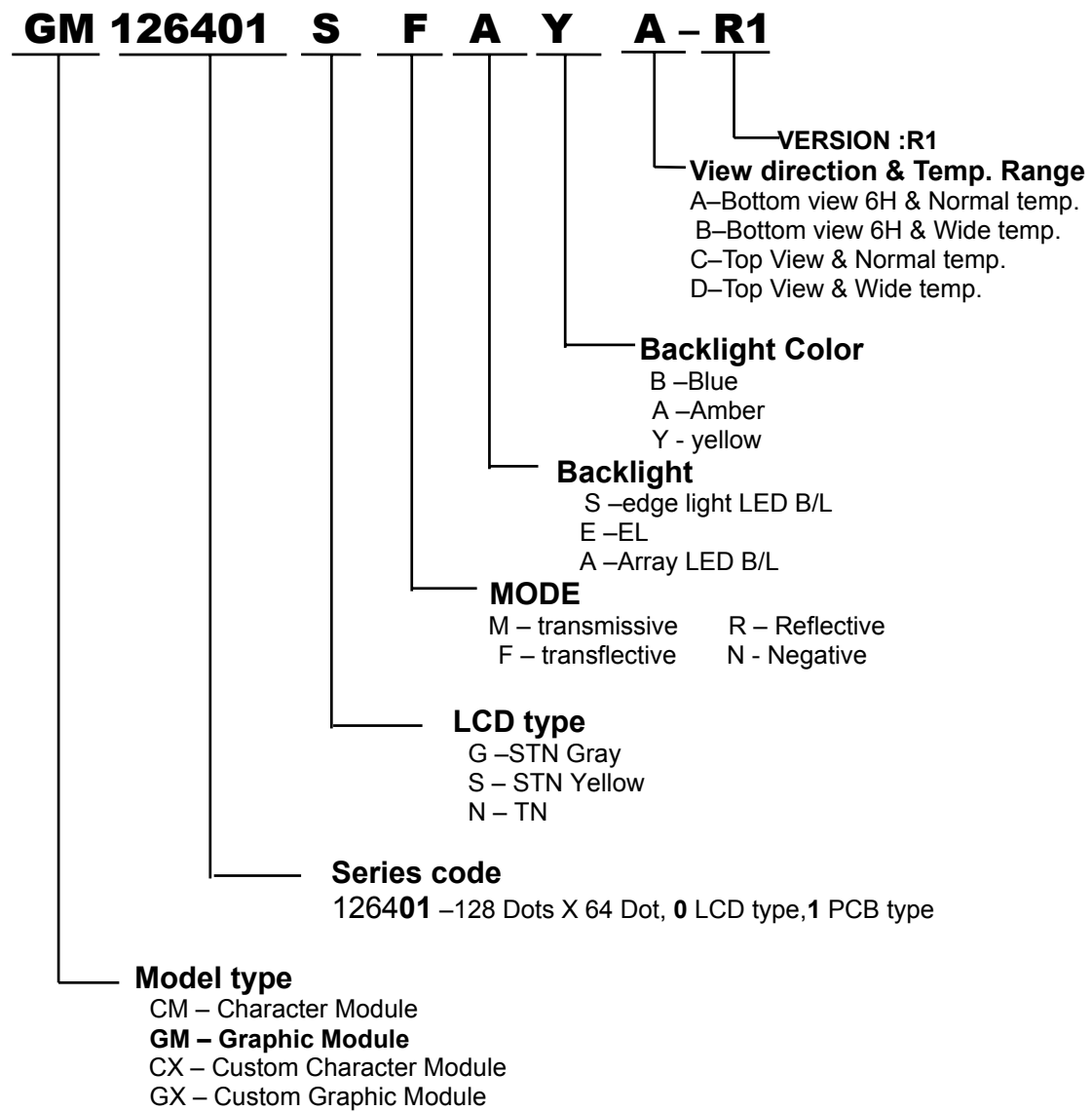
Inspection level: Level II

Sampling table: MIL-STD-105E

12. LOT NUMBERING SYSTEM



13. LCM NUMBERING SYSTEM



14. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handling,

- (1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degradation, polarizer peel off or bubble.
- (2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface, wipe gently with cotton, chamois or other soft material soaked in petroleum benzin.
- (3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.
- (4). Glass can be easily chipped or cracked from rough handling, especially at corners and edges.
- (5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

- (1). Do not tamper in any way with the tabs on the metal frame.
- (2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.
- (3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).
- (4). When mounting a LCM make sure that the PCB is not under any stress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.
- (5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

2.2 Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

- (1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.
- (2). The modules should be kept in antistatic bags or other containers resistant to static for storage.
- (3). Only properly grounded soldering irons should be used.
- (4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

2.3 Soldering

- (1). Solder only to the I/O terminals.
- (2). Use only soldering irons with proper grounding and no leakage.
- (3). Soldering temperature : $280^{\circ}\text{C} \pm 10^{\circ}\text{C}$
- (4). Soldering time: 3 to 4 sec.
- (5). Use eutectic solder with resin flux fill.
- (6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4 Operation

- (1). The viewing angle can be adjusted by varying the LCD driving voltage V_0 .
- (2). Driving voltage should be kept within specified range; excess voltage shortens display life.
- (3). Response time increases with decrease in temperature.
- (4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".
- (5). Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

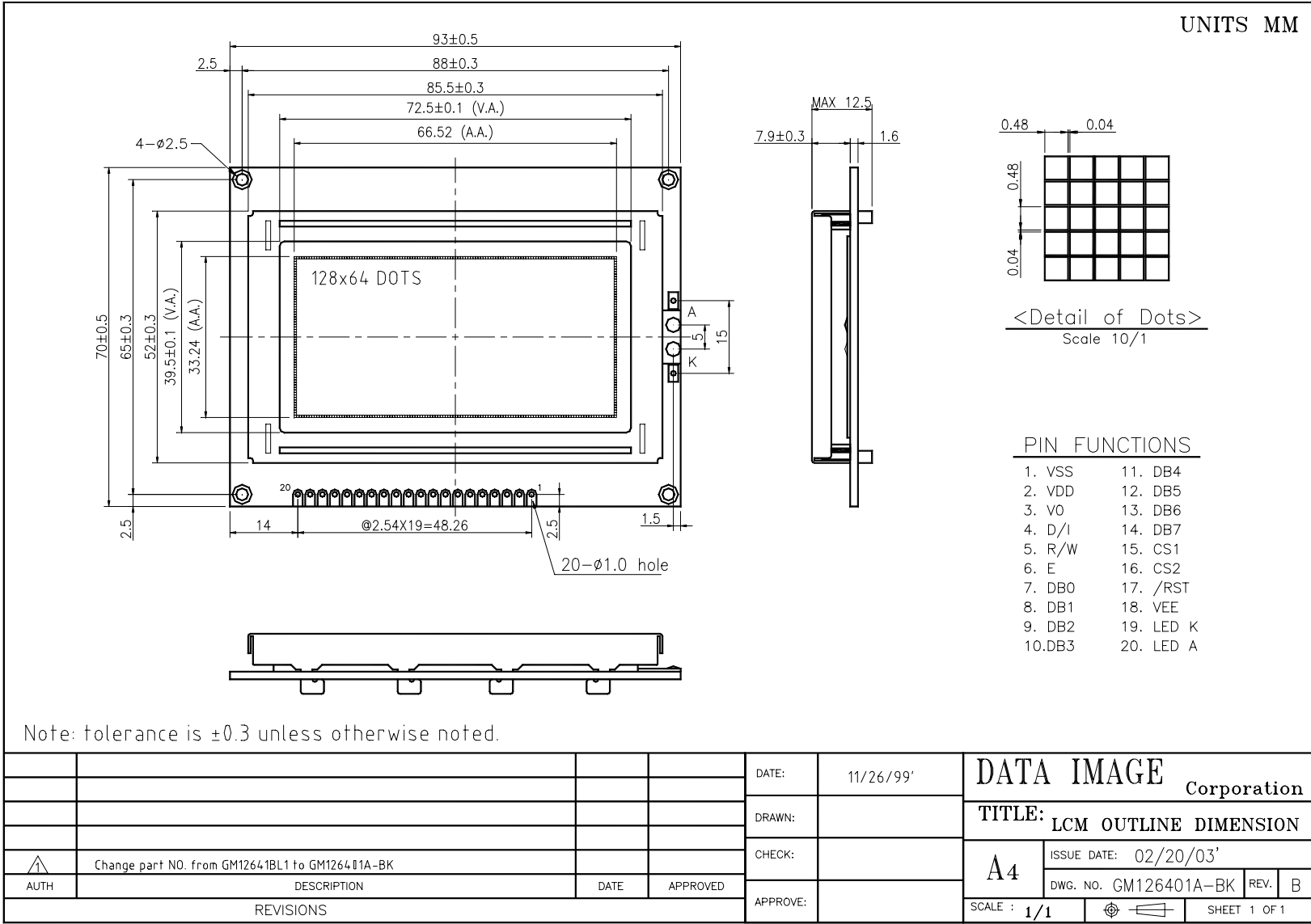
2.5 Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

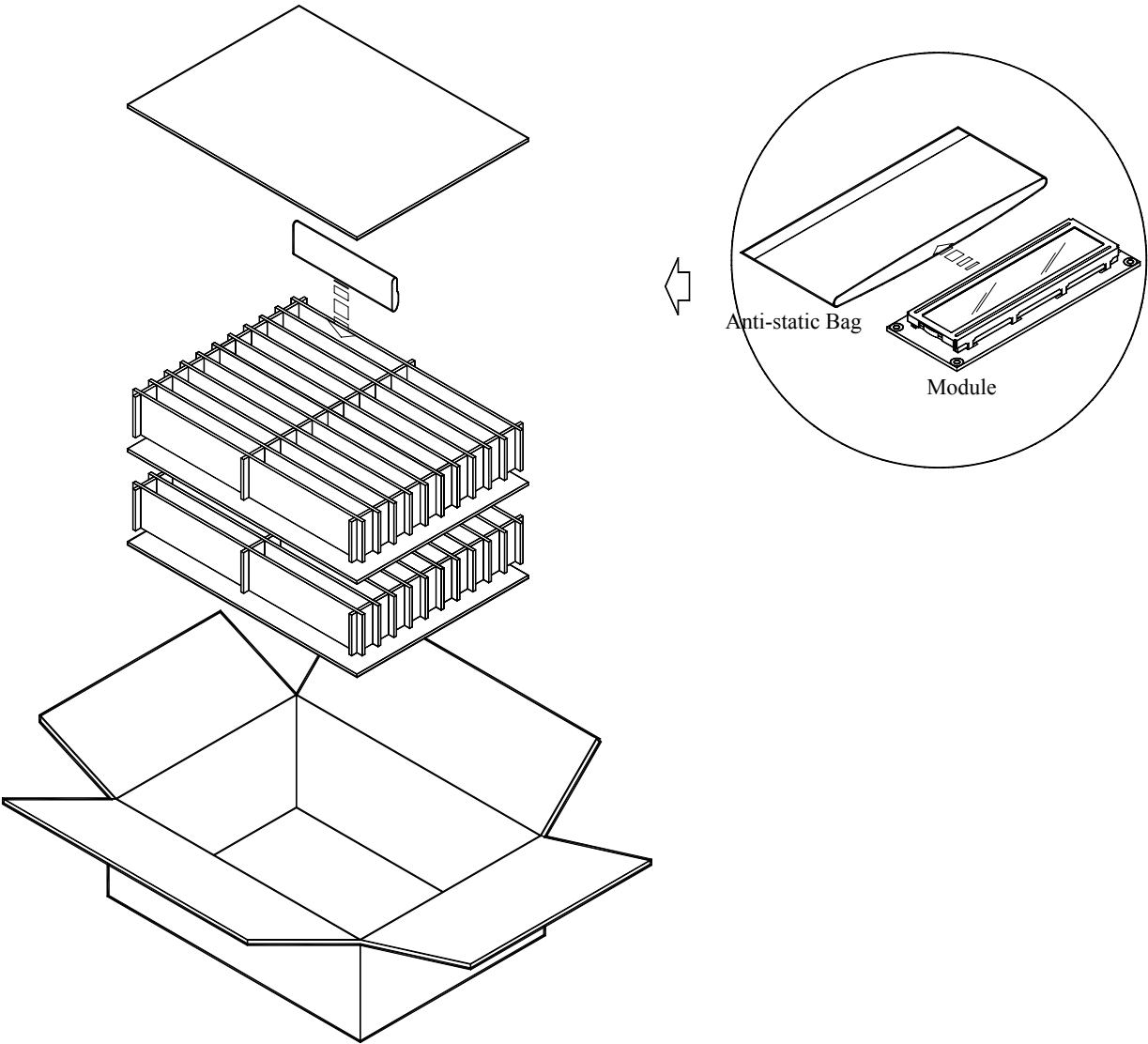
2.6 Limited Warranty

Unless otherwise agreed between DATA IMAGE and customer, DATA IMAGE will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with DATA IMAGE acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DATA IMAGE is limited to repair and/or replacement on the terms set forth above. DATA IMAGE will not responsible for any subsequent or consequential events.

15 OUTLINE DRAWING



16 . PACKAGE INFORMATION



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Datasheets for electronic components.